

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1 – 5 (Cancelled).

6. (Currently amended): A heat resistant flexible laminate obtained by the method for manufacturing a heat resistant flexible laminate comprising a step of laminating a heat resistant adhesive material and a metallic foil by thermal lamination in a temperature range of not less than 200 degrees C, wherein a film-like protective material is disposed between a pressurized surface and the metallic foil at the time of thermal lamination, and

coefficients of linear expansion of the heat resistant adhesive material and the protective material in a temperature range of 200 degrees C to 300 degrees C are within a range of $\alpha_0 \pm 10$ ppm/degree C, when a coefficient of linear expansion of the metallic foil is defined as α_0 , wherein the metallic foil is a rolled copper foil or an electrolytic copper foil

7. (Original): The heat resistant flexible laminate according to Claim 6, wherein a percentage of dimensional change between before and after removal of at least a portion of the metallic foil by etching is in a range of $\pm 0.05\%$.